

PNP General-Purpose Amplifier

NSVT5401MR6

Features

- This Device Has Matched Dies
- AEC-Q101 Qualified and PPAP Capable
- These Devices are Pb–Free, Halogen Free/BFR Free and are RoHS Compliant

ABSOLUTE MAXIMUM RATINGS (Notes 1, 2)

(T_A = 25°C, unless otherwise noted)

Rating	Symbol	Value	Unit
Collector - Emitter Voltage	V _{CEO}	-150	V
Collector - Base Voltage	V _{CBO}	-160	V
Emitter - Base Voltage	V _{EBO}	-5.0	V
Collector Current - Continuous	I _C	-600	mA
Operating and Storage Junction Temperature Range	T _J , T _{STG}	-55 to +150	°C

Stresses exceeding those listed in the Maximum Ratings table may damage the device. If any of these limits are exceeded, device functionality should not be assumed, damage may occur and reliability may be affected.

- 1. These ratings are based on a maximum junction temperature of 150 $^{\circ}$ C.
- These are steady-state limits. onsemi should be consulted on applications involving pulsed or low-duty-cycle operations.

THERMAL CHARACTERISTICS (Note 3)

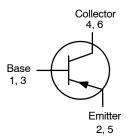
(T_A = 25°C, unless otherwise noted)

Characteristic	Symbol	Max	Unit
Total Device Dissipation	P_{D}	700	mW
Thermal Resistance, Junction-to-Ambient, Total	$R_{\theta JA}$	180	°C/W

1

3. Device mounted on a 1 in 2 pad of 2 oz copper.

ELECTRICAL CONNECTION





TSOT23 6-Lead CASE 419BL

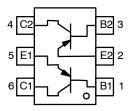
MARKING DIAGRAM



4S2 = Specific Device Code

M = Date Code

PIN ASSIGNMENT



ORDERING INFORMATION

Device	Package	Shipping [†]
NSVT5401MR6T1G	TSOT23-6 (Pb-Free)	3000 / Tape & Reel

†For information on tape and reel specifications, including part orientation and tape sizes, please refer to our Tape and Reel Packaging Specifications Brochure, BRD8011/D.

NSVT5401MR6

ELECTRICAL CHARACTERISTICS ($T_A = 25^{\circ}C$ unless otherwise noted)

Parameter	Symbol	Test Condition	Min	Max	Unit
Collector-Emitter Breakdown Voltage (Note 4)	BV _{CEO}	$I_C = -1.0 \text{ mA}, I_B = 0$	-150	-	V
Collector-Base Breakdown Voltage	BV _{CBO}	$I_C = -100 \mu\text{A}, I_E = 0$	-160	-	V
Emitter-Base Breakdown Voltage	BV _{EBO}	$I_E = -10 \mu A, I_C = 0$	-5.0	-	V
Collector Cut-Off Current	I _{CBO}	$V_{CB} = -120 \text{ V}, I_{E} = 0$	_	-50	nA
		$V_{CB} = -120 \text{ V}, I_E = 0, T_A = 100^{\circ}\text{C}$	_	-50	μΑ
Emitter Cut-Off Current	I _{EBO}	$V_{EB} = -3 \text{ V}, I_{C} = 0$	_	-50	nA
DC Current Gain (Note 4)	h _{FE1}	$V_{CE} = -5 \text{ V}, I_{C} = -1 \text{ mA}$	50	-	-
Variation Ratio of h _{FE1} Between Die 1 and Die 2	DIVID1	h _{FE1} (Die1) / h _{FE1} (Die2)	0.9	1.1	-
DC Current Gain (Note 4)	h _{FE2}	$V_{CE} = -5 \text{ V}, I_{C} = -10 \text{ mA}$	60	240	-
Variation Ratio of h _{FE2} Between Die 1 and Die 2	DIVID2	h _{FE2} (Die1) / h _{FE2} (Die2)	0.95	1.05	-
DC Current Gain (Note 4)	h _{FE3}	$V_{CE} = -5 \text{ V}, I_{C} = -50 \text{ mA}$	50	_	-
Variation Ratio of h _{FE3} Between Die 1 and Die 2	DIVID3	h _{FE3} (Die1) / h _{FE3} (Die2)	0.9	1.1	-
Collector-Emitter Saturation Voltage (Note 4)	V _{CE} (sat)	$I_{\rm C} = -10 \text{ mA}, I_{\rm B} = -1 \text{ mA}$	-	-0.2	V
		$I_{\rm C} = -50 \text{ mA}, I_{\rm B} = -5 \text{ mA}$	-	-0.5	1
Base-Emitter Saturation Voltage	V _{BE} (sat)	$I_{\rm C} = -10 \text{ mA}, I_{\rm B} = -1 \text{ mA}$	-	-1	V
(Note 4)		$I_{\rm C} = -50$ mA, $I_{\rm B} = -5$ mA	_	-1	1
Base-Emitter On Voltage (Note 4)	V _{BE} (on)	$V_{CE} = -5 \text{ V}, I_{C} = -10 \text{ mA}$	_	-1	V
Difference of V _{BE} (on) Between Die1 and Die 2	DEL	V _{BE} (on)(Die) – V _{BE} (on)(Die2)	-8	8	mV
Current Gain Bandwidth Product	f _T	$V_{CE} = -10 \text{ V, } I_{C} = -10 \text{ mA,}$ f = 100 MHz	100	300	MHz
Output Capacitance	C _{ob}	V _{CB} = -10 V, I _E = 0, f = 1 MHz	-	6.0	pF
Noise Figure	NF	V_{CE} = -5.0 V, I_{C} = -250 μA, R_{S} = 1.0 kΩ f = 10 Hz to 15.7 kHz	-	8.0	dB

Product parametric performance is indicated in the Electrical Characteristics for the listed test conditions, unless otherwise noted. Product performance may not be indicated by the Electrical Characteristics if operated under different conditions.

4. Pulse test: Pulse width ≤ 300 ms, duty cycle ≤ 2%

NSVT5401MR6

TYPICAL PERFORMANCE CHARACTERISTICS

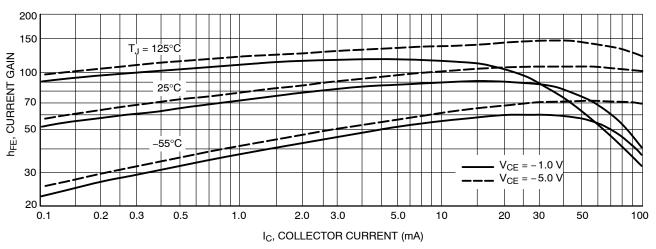


Figure 1. DC Current Gain

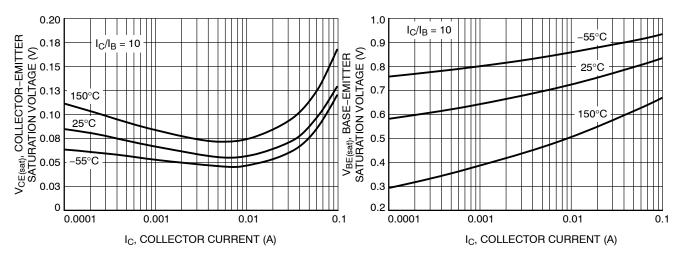


Figure 2. Collector Emitter Saturation Voltage vs. Collector Current

Figure 3. Base Emitter Saturation Voltage vs.
Collector Current

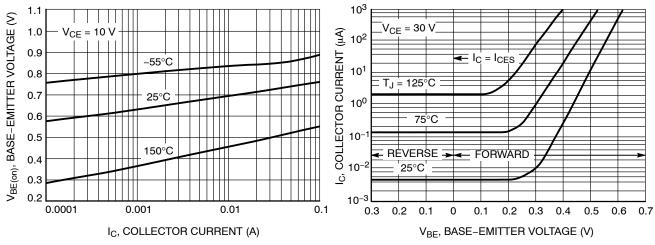


Figure 4. Base Emitter Voltage vs. Collector Current

Figure 5. Collector Cut-Off Region

NSVT5401MR6

TYPICAL PERFORMANCE CHARACTERISTICS (continued)

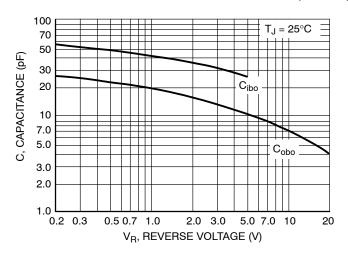
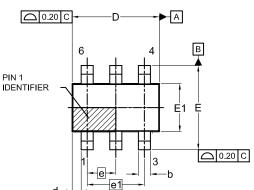


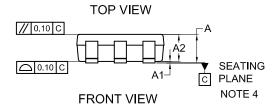
Figure 6. Capacitances

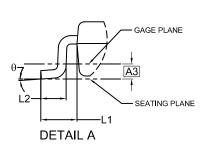


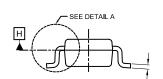
TSOT23 6-Lead CASE 419BL **ISSUE A**

DATE 31 AUG 2020









SIDE VIEW

SYMM €
0.95
1.00 MIN
2.60
l l-0.70 M I N

LAND PATTERN RECOMMENDATION

*FOR ADDITIONAL INFORMATION ON OUR PB-FREE STRATEGY AND SOLDERING DETAILS, PLEASE DOWNLOAD THE ON SEMICONDUCTOR SOLDERING AND MOUNTING TECHNIQUES REFERENCE MANUAL, SOLDERRM/D.



- 1. DIMENSIONING AND TOLERANCING PER ASME Y14.5M, 2009.
- CONTROLLING DIMENSION: MILLIMETERS
 DIMENSIONS D AND E1 DO NOT INCLUDE MOLD FLASH,
 PROTRUSIONS, OR GATE BURRS. MOLD FLASH, PROTRUSIONS OR GATE BURRS SHALL NOT EXCEED 0.25MM PER END. DIMENSIONS D AND E1 ARE DETERMINED AT DATUM H.
- 4. SEATING PLANE IS DEFINED BY THE TERMINALS. "A1" IS DEFINED AS THE DISTANCE FROM THE SEATING PLANE TO THE LOWEST POINT ON THE PACKAGE BODY.

DIM	l N	MILLIMETERS		
D ₁ ,v,	MIN.	NOM.	MAX.	
Α	0.90	1.00	1.10	
A1	0.00	0.05	0.10	
A2	0.70	0.85	1.00	
А3	0.25 BSC			
b	0.25	0.38	0.50	
С	0.10	0.18	0.26	
D	2.80	2.95	3.10	
d	0.30 REF			
Е	2.50	2.75	3.00	
E1	1.30	1.50	1.70	
е	0.95 BSC			
e1	1.90 BSC			
L1	0.60 REF			
L2	0.20	0.40	0.60	
θ	0°	-	10°	

GENERIC MARKING DIAGRAM*



XXX = Specific Device Code

= Date Code Μ

= Pb-Free Package

(Note: Microdot may be in either location)

*This information is generic. Please refer to device data sheet for actual part marking. Pb-Free indicator, "G" or microdot " ■", may or may not be present. Some products may not follow the Generic Marking.

DOCUMENT NUMBER:	98AON83292G	Electronic versions are uncontrolled except when accessed directly from the Document Repositor, Printed versions are uncontrolled except when stamped "CONTROLLED COPY" in red.		
DESCRIPTION:	TSOT23 6-Lead		PAGE 1 OF 1	

ON Semiconductor and un are trademarks of Semiconductor Components Industries, LLC dba ON Semiconductor or its subsidiaries in the United States and/or other countries. ON Semiconductor reserves the right to make changes without further notice to any products herein. ON Semiconductor makes no warranty, representation or guarantee regarding the suitability of its products for any particular purpose, nor does ON Semiconductor assume any liability arising out of the application or use of any product or circuit, and specifically disclaims any and all liability, including without limitation special, consequential or incidental damages. ON Semiconductor does not convey any license under its patent rights nor the rights of others.

onsemi, Onsemi, and other names, marks, and brands are registered and/or common law trademarks of Semiconductor Components Industries, LLC dba "onsemi" or its affiliates and/or subsidiaries in the United States and/or other countries. onsemi owns the rights to a number of patents, trademarks, copyrights, trade secrets, and other intellectual property. A listing of onsemi's product/patent coverage may be accessed at www.onsemi.com/site/pdf/Patent-Marking.pdf. Onsemi reserves the right to make changes at any time to any products or information herein, without notice. The information herein is provided "as-is" and onsemi makes no warranty, representation or guarantee regarding the accuracy of the information, product features, availability, functionality, or suitability of its products for any particular purpose, nor does onsemi assume any liability arising out of the application or use of any product or circuit, and specifically disclaims any and all liability, including without limitation special, consequential or incidental damages. Buyer is responsible for its products and applications using onsemi products, including compliance with all laws, regulations and safety requirements or standards, regardless of any support or applications information provided by onsemi. "Typical" parameters which may be provided in onsemi data sheets and/or specifications can and do vary in different applications and actual performance may vary over time. All operating parameters, including "Typicals" must be validated for each customer application by customer's technical experts. onsemi does not convey any license under any of its intellectual property rights nor the rights of others. onsemi products are not designed, intended, or authorized for use as a critical component in life support systems or any FDA class 3 medical devices with a same or similar classification in a foreign jurisdiction or any devices intended for implantation in the human body. Should Buyer purchase

ADDITIONAL INFORMATION

TECHNICAL PUBLICATIONS:

 $\textbf{Technical Library:} \ \underline{www.onsemi.com/design/resources/technical-documentation}$

onsemi Website: www.onsemi.com

ONLINE SUPPORT: www.onsemi.com/support

For additional information, please contact your local Sales Representative at

www.onsemi.com/support/sales